

# **PSMN5R6-100XS**

N-channel 100V 5.6 m $\Omega$  standard level MOSFET in TO220F (SOT186A)

Rev. 3 — 6 March 2012

**Product data sheet** 

#### **Product profile** 1.

#### **1.1 General description**

Standard level N-channel MOSFET in TO220F (SOT186A) package qualified to 175C. This product is designed and qualified for use in a wide range of industrial, communications and domestic equipment.

#### 1.2 Features and benefits

High efficiency due to low switching and conduction losses

#### 1.3 Applications

- AC-to-DC power supply equipment
- Motor control

1.4 Quick reference data

- Isolated package
- Suitable for standard level gate drive
- Server power supplies
- Synchronous rectification

Table 1.	Quick reference data					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> ≥ 25 °C; T <sub>j</sub> ≤ 175 °C	-	-	100	V
I <sub>D</sub>	drain current	$T_{mb}$ = 25 °C; $V_{GS}$ = 10 V; see <u>Figure 1</u>	-	-	61.8	А
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; see <u>Figure 2</u>	-	-	60	W
Static cha	aracteristics					
R <sub>DSon</sub>	drain-source on-state resistance	$V_{GS}$ = 10 V; $I_D$ = 15 A; $T_j$ = 25 °C; see <u>Figure 12</u> ; see <u>Figure 13</u>	-	4.3	5.6	mΩ
Dynamic	characteristics					
Q <sub>GD</sub>	gate-drain charge	$V_{GS}$ = 10 V; I <sub>D</sub> = 15 A; V <sub>DS</sub> = 50 V; see	-	41.2	-	nC
Q <sub>G(tot)</sub>	total gate charge	Figure 14; see Figure 15	-	145	-	nC
	e ruggedness					
E <sub>DS(AL)S</sub>	non-repetitive drain-source avalanche energy	$      V_{GS} = 10 \text{ V}; T_{j(init)} = 25 \text{ °C}; I_D = 61.8 \text{ A}; \\       V_{sup} \leq 100 \text{ V}; \text{ unclamped}; R_{GS} = 50 \Omega; \\       see \underline{Figure 3} $	-	-	550	mJ



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### 2. Pinning information

Table 2.	Pinning	j information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		-
2	D	drain	mb	
3	S	source		
mb		mounting base; isolated		mbb076 S

SOT186A (TO-220F)

### 3. Ordering information

#### Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PSMN5R6-100XS	TO-220F	plastic single-ended package; isolated heatsink mounted; 1 mounting hole; 3-lead TO-220 "full pack"	SOT186A

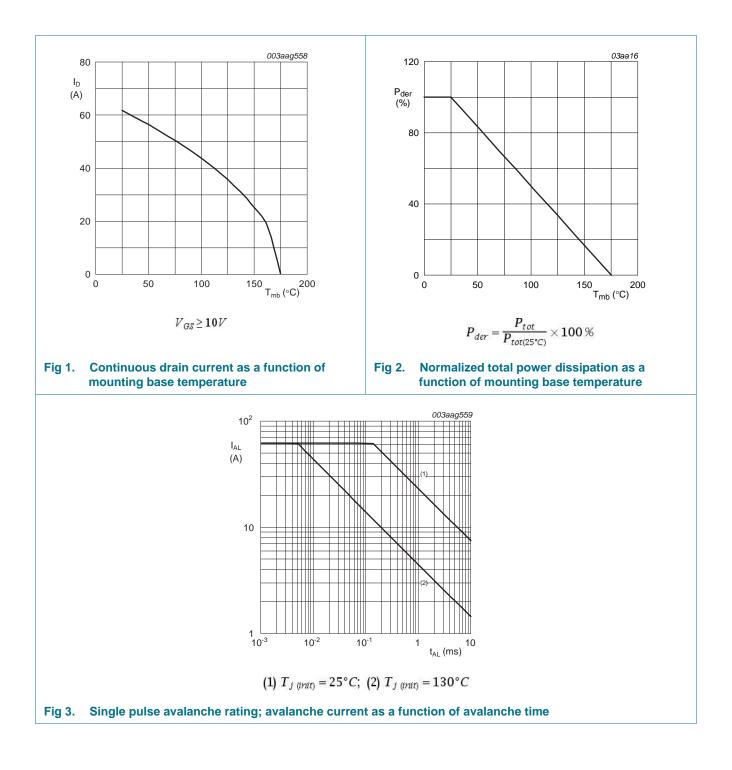
### 4. Limiting values

#### Table 4.Limiting values

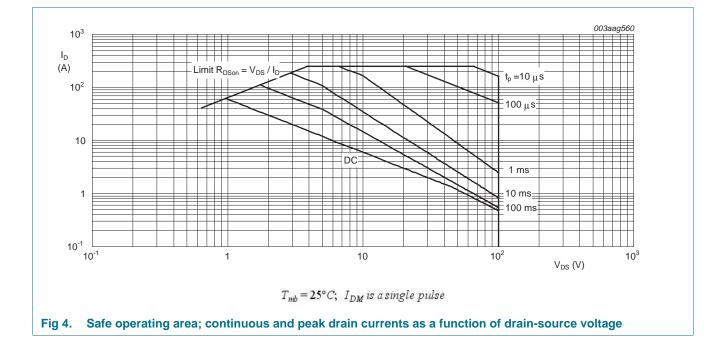
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> ≥ 25 °C; T <sub>j</sub> ≤ 175 °C	-	100	V
V <sub>DGR</sub>	drain-gate voltage	T <sub>j</sub> ≥ 25 °C; T <sub>j</sub> ≤ 175 °C; R <sub>GS</sub> = 20 kΩ	-	100	V
V <sub>GS</sub>	gate-source voltage		-20	20	V
I <sub>D</sub>	drain current	V <sub>GS</sub> = 10 V; T <sub>mb</sub> = 25 °C; see <u>Figure 1</u>	-	61.8	А
		$V_{GS}$ = 10 V; $T_{mb}$ = 100 °C; see <u>Figure 1</u>	-	43.7	А
I <sub>DM</sub>	peak drain current	pulsed; $t_p \le 10 \ \mu s$ ; $T_{mb} = 25 \ ^{\circ}C$ ; see Figure 4	-	247	А
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; see <u>Figure 2</u>	-	60	W
T <sub>stg</sub>	storage temperature		-55	175	°C
Tj	junction temperature		-55	175	°C
T <sub>sld(M)</sub>	peak soldering temperature		-	260	°C
Source-d	rain diode				
Is	source current	T <sub>mb</sub> = 25 °C	-	50	А
I <sub>SM</sub>	peak source current	pulsed; $t_p \le 10 \ \mu s$ ; $T_{mb} = 25 \ ^{\circ}C$	-	247	А
Avalanch	e ruggedness				
E <sub>DS(AL)S</sub>	non-repetitive drain-source avalanche energy	$V_{GS}$ = 10 V; $T_{j(init)}$ = 25 °C; $I_D$ = 61.8 A; $V_{sup}$ ≤ 100 V; unclamped; $R_{GS}$ = 50 Ω; see <u>Figure 3</u>	-	550	mJ
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### 5. Thermal characteristics

Thermal characteristics

Table 5.	Inermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R <sub>th(j-mb)</sub>	thermal resistance from junction to mounting base	see Figure 5	-	2.2	2.5	K/W
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	vertical in free air	-	55	-	K/W

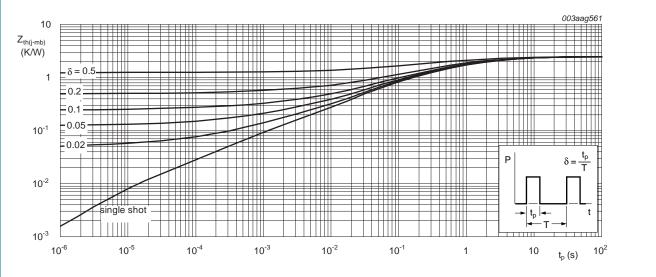


Fig 5. Transient thermal impedance from junction to mounting base as a function of pulse duration

### 6. Isolation characteristics

Table 6.	Isolation characteristics						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
C <sub>isol</sub>	isolation capacitance		[1]	-	10	-	pF
V <sub>isol(RMS)</sub>	RMS isolation voltage	50 Hz $\leq$ f $\leq$ 60 Hz; RH $\leq$ 65 %; sinusoidal waveform; clean and dust free		-	-	2500	V

[1] f = 1 MHz

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### 7. Characteristics

Table 7.	Characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					
V <sub>(BR)DSS</sub>	drain-source breakdown	$I_D = 250 \ \mu A; \ V_{GS} = 0 \ V; \ T_j = 25 \ ^\circ C$	100	-	-	V
	voltage	$I_D = 250 \ \mu A; \ V_{GS} = 0 \ V; \ T_j = -55 \ ^\circ C$	90	-	-	V
V <sub>GS(th)</sub>	gate-source threshold voltage	$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 25 \text{ °C};$ see Figure 10; see Figure 11	2	3	4	V
		$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 175 \text{ °C};$ see Figure 10	1	-	-	V
		$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = -55 \text{ °C};$ see Figure 10	-	-	4.6	V
DSS	drain leakage current	$V_{DS}$ = 100 V; $V_{GS}$ = 0 V; $T_j$ = 25 °C	-	-	10	μA
		V <sub>DS</sub> = 100 V; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 100 °C	-	-	200	μA
GSS	gate leakage current	$V_{GS} = 20 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	2	100	nA
		$V_{GS} = -20 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	2	100	nA
R <sub>DSon</sub> drain-source on-s resistance	drain-source on-state resistance	$V_{GS}$ = 10 V; $I_D$ = 15 A; $T_j$ = 25 °C; see Figure 12; see Figure 13	-	4.3	5.6	mΩ
		$V_{GS}$ = 10 V; I <sub>D</sub> = 15 A; T <sub>j</sub> = 100 °C; see <u>Figure 13</u>	-	7.5	9.8	mΩ
		$V_{GS} = 10 \text{ V}; I_D = 15 \text{ A}; T_j = 175 \text{ °C};$ see Figure 13	-	12	15.7	mΩ
R <sub>G</sub>	internal gate resistance (AC)	f = 1 MHz	-	0.97	-	Ω
Dynamic	characteristics					
Q <sub>G(tot)</sub>	total gate charge	$I_D = 15 \text{ A}; V_{DS} = 50 \text{ V}; V_{GS} = 10 \text{ V};$	-	145	-	nC
Q <sub>GS</sub>	gate-source charge	see Figure 14; see Figure 15	-	32.5	-	nC
Q <sub>GS(th)</sub>	pre-threshold gate-source charge		-	13.1	-	nC
Q <sub>GS(th-pl)</sub>	post-threshold gate-source charge		-	19.4	-	nC
Q <sub>GD</sub>	gate-drain charge		-	41.2	-	nC
V <sub>GS(pl)</sub>	gate-source plateau voltage	$I_D = 15 \text{ A}; V_{DS} = 50 \text{ V}; \text{ see } \frac{\text{Figure } 14}{\text{Figure } 15};$	-	4.2	-	V
C <sub>iss</sub>	input capacitance	$V_{DS} = 50 \text{ V}; V_{GS} = 0 \text{ V}; f = 1 \text{ MHz};$ $T_j = 25 \text{ °C}; \text{ see } \frac{\text{Figure } 16}{16};$ see $\frac{\text{Figure } 17}{16}$	-	8061	-	pF
C <sub>oss</sub>	output capacitance	$V_{DS} = 50 \text{ V}; V_{GS} = 0 \text{ V}; f = 1 \text{ MHz};$ $T_j = 25 \text{ °C}; \text{ see } \frac{\text{Figure } 16}{100000000000000000000000000000000000$	-	561	-	pF
S <sub>rss</sub>	reverse transfer capacitance	$V_{DS} = 50 \text{ V}; V_{GS} = 0 \text{ V}; f = 1 \text{ MHz};$ $T_j = 25 \text{ °C}; \text{ see } \frac{\text{Figure } 16}{16};$ $\text{see } \frac{\text{Figure } 17}{16}$	-	330	-	pF
d(on)	turn-on delay time	$V_{DS} = 50 \text{ V}; \text{ R}_{L} = 4 \Omega; V_{GS} = 10 \text{ V}; \label{eq:VDS}$	-	35	-	ns
r	rise time	$R_{G(ext)} = 4.7 \ \Omega; \ T_{j} = 25 \ ^{\circ}C$	-	38	-	ns
d(off)	turn-off delay time		-	116	-	ns
f	fall time		-	49	-	ns

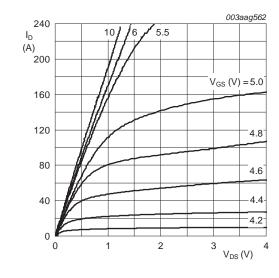
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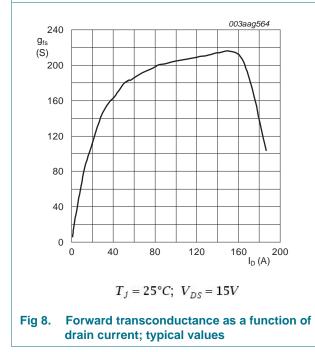
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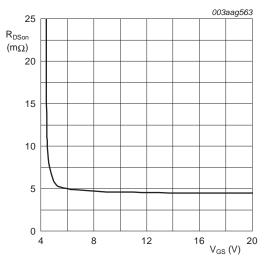
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Source-dra	Source-drain diode					
$V_{SD}$	source-drain voltage	I <sub>S</sub> = 10 A; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C; see <u>Figure 18</u>	-	0.75	1.2	V
t <sub>rr</sub>	reverse recovery time	I <sub>S</sub> = 10 A; dI <sub>S</sub> /dt = -100 A/µs;	-	67	-	ns
Qr	recovered charge	$V_{GS} = 0 V; V_{DS} = 50 V$	-	182	-	nC

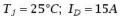














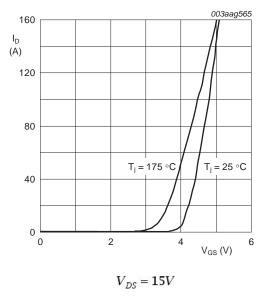
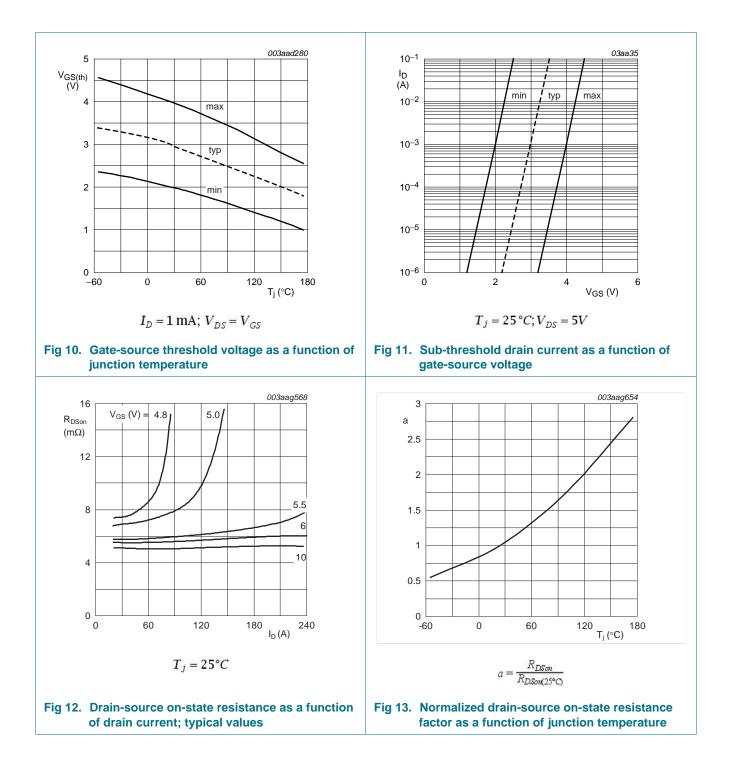
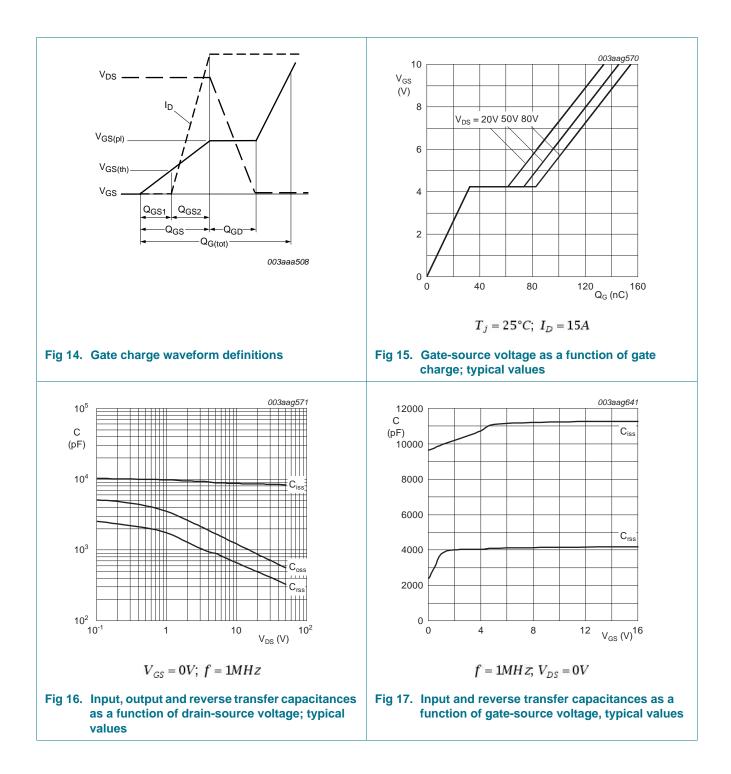


Fig 9. Transfer characteristics; drain current as a function of gate-source voltage; typical values

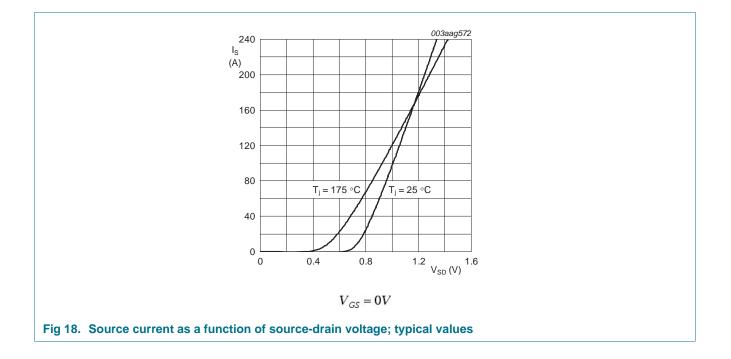
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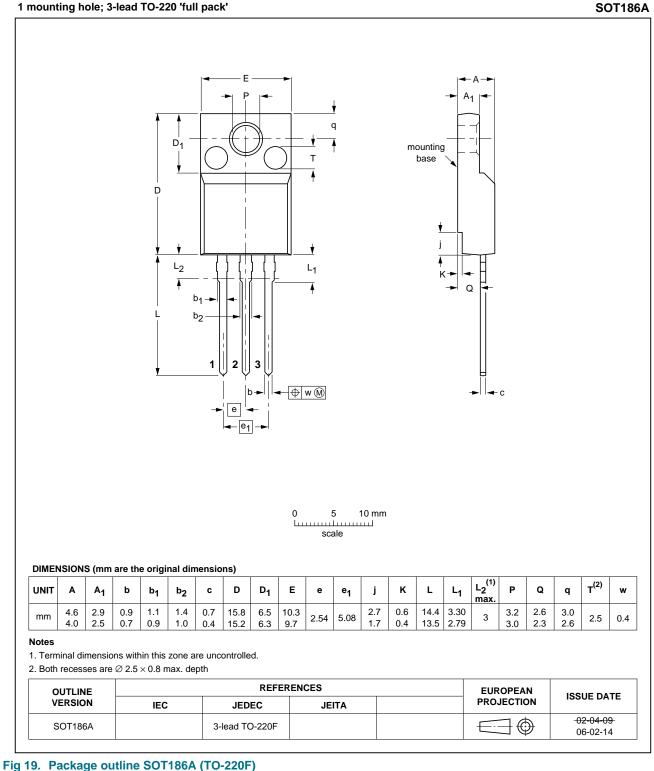
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## **PSMN5R6-100XS**

#### N-channel 100V 5.6 mΩ standard level MOSFET in TO220F (SOT186A)

#### **Package outline** 8.



Plastic single-ended package; isolated heatsink mounted; 1 mounting hole; 3-lead TO-220 'full pack'

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### 9. Revision history

Table 8.	Revision histor	у
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Document ID	Release date	Data sheet status	Change notice	Supersedes
PSMN5R6-100XS v.3	20120306	Product data sheet	-	PSMN5R6-100XS v.2
Modifications:	<ul> <li>Status changed from</li> </ul>	om preliminary to product.		
	<ul> <li>Various changes to</li> </ul>	o content.		
PSMN5R6-100XS v.2	20110926	Preliminary data sheet	-	PSMN5R6-100XS v.1

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### **10. Legal information**

#### 10.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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